

DMG301NU-13 Datasheet



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DiGi Electronics Part Number	DMG301NU-13-DG
Manufacturer	Diodes Incorporated
Manufacturer Product Number	DMG301NU-13
Description	MOSFET N-CH 25V 260MA SOT23
Detailed Description	N-Channel 25 V 260mA (Ta) 320mW (Ta) Surface Mount SOT-23-3



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

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Purchase and inquiry

Manufacturer Product Number:

DMG301NU-13

Series:

-

FET Type:

N-Channel

Drain to Source Voltage (Vdss):

25 V

Drive Voltage (Max Rds On, Min Rds On):

2.7V, 4.5V

Vgs(th) (Max) @ Id:

1.1V @ 250 μ A

Vgs (Max):

8V

FET Feature:

-

Operating Temperature:

-55°C ~ 150°C (Tj)

Supplier Device Package:

SOT-23-3

Base Product Number:

DMG301

Manufacturer:

Diodes Incorporated

Product Status:

Active

Technology:

MOSFET (Metal Oxide)

Current - Continuous Drain (Id) @ 25°C:

260mA (Ta)

Rds On (Max) @ Id, Vgs:

40hm @ 400mA, 4.5V

Gate Charge (Qg) (Max) @ Vgs:

0.36 nC @ 4.5 V

Input Capacitance (Ciss) (Max) @ Vds:

27.9 pF @ 10 V

Power Dissipation (Max):

320mW (Ta)

Mounting Type:

Surface Mount

Package / Case:

TO-236-3, SC-59, SOT-23-3

Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8541.21.0095

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99



DMG301NU

25V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D $T_A = +25^\circ\text{C}$
25V	4Ω @ $V_{GS} = 4.5\text{V}$	0.26A
	5Ω @ $V_{GS} = 2.7\text{V}$	0.23A

Description

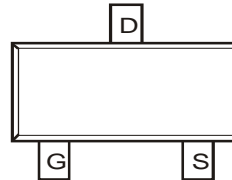
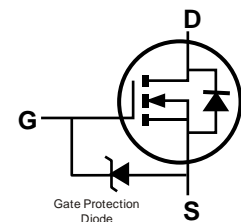
This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- DC-DC Converters
- Power Management Functions
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.



Top View

Top View
Pin Configuration

Equivalent Circuit

Features

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Small Surface Mount Package
- ESD Protected Gate (>6kV Human Body Model)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- Halogen and Antimony Free. "Green" Device (Note 3)**
- Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

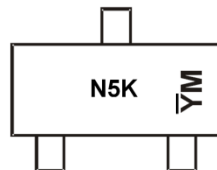
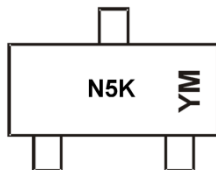
- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208 **e3**
- Lead Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe).
- Terminal Connections: See Diagram
- Weight: 0.008 grams (Approximate)

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DMG301NU-7	Standard	SOT23	3,000/Tape & Reel
DMG301NU-13	Standard	SOT23	10,000/Tape & Reel

- Notes:
- No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 - See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 - For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



N5K = Product Type Marking Code
 YM = Date Code Marking for SAT (Shanghai Assembly/ Test Site)
 YM = Date Code Marking for CAT (Chengdu Assembly/ Test Site)
 Y or Ȳ = Year (ex: A = 2013)
 M = Month (ex: 9 = September)

Date Code Key

Year	2011	2012	2013	2014	2015	2016	2017
Code	Y	Z	A	B	C	D	E

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D


Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V _{DSS}	25	V
Gate-Source Voltage			V _{GSS}	8	V
Continuous Drain Current (Note 6) V _{GS} = 4.5V	Steady State	T _A = +25°C	I _D	0.26	A
		T _A = +70°C		0.21	
Continuous Drain Current (Note 6) V _{GS} = 2.7V	Steady State	T _A = +25°C	I _D	0.23	A
		T _A = +70°C		0.18	
Pulsed Drain Current (10μs pulse, duty cycle = 1%)			I _{DM}	1.5	A
Maximum Body Diode Continuous Current (Note 6)			I _S	0.5	A

Thermal Characteristics

Characteristic		Symbol	Value	Units
Total Power Dissipation	(Note 5)	P _D	0.32	W
	(Note 6)		0.4	
Thermal Resistance, Junction to Ambient	(Note 5)	R _{θJA}	369	°C/W
	(Note 6)		296	
Thermal Resistance, Junction to Case	(Note 6)	R _{θJC}	115	°C
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	25	—	—	V	V _{GS} = 0V, I _D = 250μA
Zero Gate Voltage Drain Current	I _{DSS}	—	—	1.0	μA	V _{DS} = 20V, V _{GS} = 0V
Gate-Body Leakage	I _{GSS}	—	—	100	nA	V _{GS} = 8V, V _{DS} = 0V
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	0.7	—	1.1	V	V _{DS} = V _{GS} , I _D = 250μA
Static Drain-Source On-Resistance	R _{DS(on)}	—	—	4	Ω	V _{GS} = 4.5V, I _D = 0.4A
		—	—	5	Ω	V _{GS} = 2.7V, I _D = 0.2A
Forward Transconductance	g _{FS}	—	1	—	S	V _{DS} = 5V, I _D = 0.4A
Diode Forward Voltage	V _{SD}	—	0.76	1.2	V	V _{GS} = 0V, I _S = 0.29A
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	—	27.9	42	pF	V _{DS} = 10V, V _{GS} = 0V, f = 1.0MHz
Output Capacitance	C _{oss}	—	6.1	9.2		
Reverse Transfer Capacitance	C _{rss}	—	2.0	3.0		
Gate Resistance	R _G	—	26.4	—	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz
Total Gate Charge	Q _g	—	0.36	—	nC	V _{GS} = 4.5V, V _{DS} = 5V, I _D = 0.2A
Gate-Source Charge	Q _{gs}	—	0.06	—		
Gate-Drain Charge	Q _{gd}	—	0.04	—		
Turn-On Delay Time	t _{D(on)}	—	2.9	—	nS	V _{GS} = 4.5V, V _{DS} = 6V I _D = 0.5A, R _{θC} = 50Ω
Turn-On Rise Time	t _r	—	1.8	—		
Turn-Off Delay Time	t _{D(off)}	—	6.6	—		
Turn-Off Fall Time	t _f	—	2.3	—		

- Notes:
- Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
 - Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout
 - Short duration pulse test used to minimize self-heating effect.
 - Guaranteed by design. Not subject to production testing.



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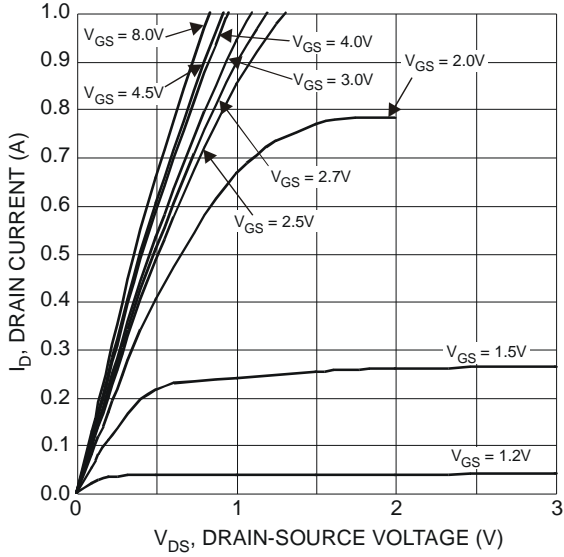


Figure 1 Typical Output Characteristics

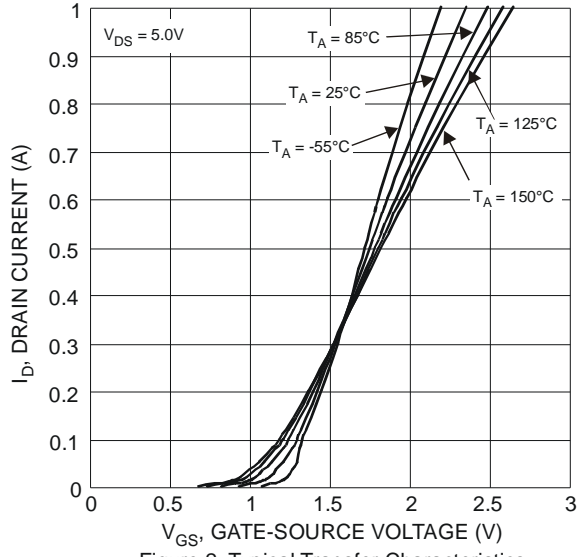


Figure 2 Typical Transfer Characteristics

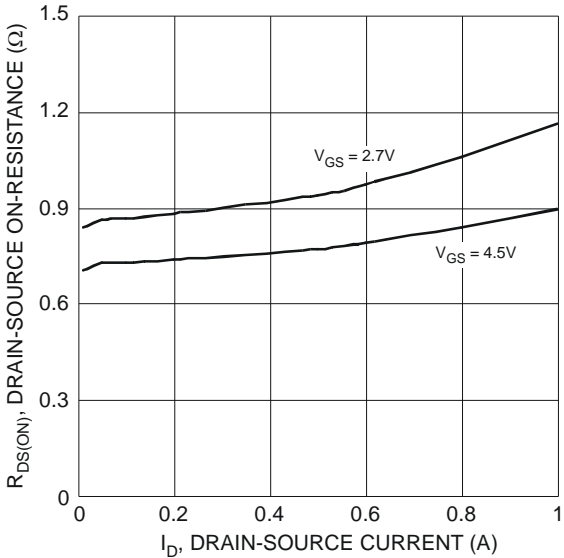


Figure 3 Typical On-Resistance vs. Drain Current and Gate Voltage

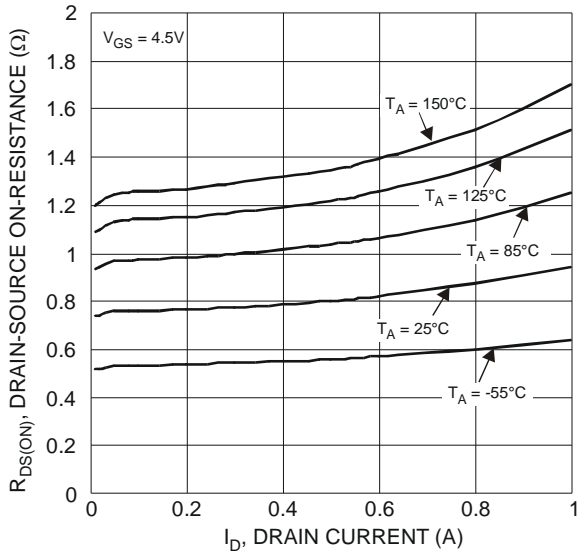


Figure 4 Typical On-Resistance vs. Drain Current and Temperature

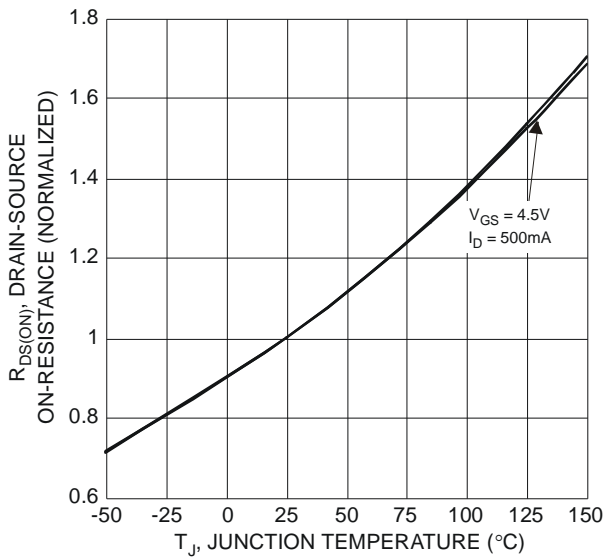


Figure 5 On-Resistance Variation with Temperature

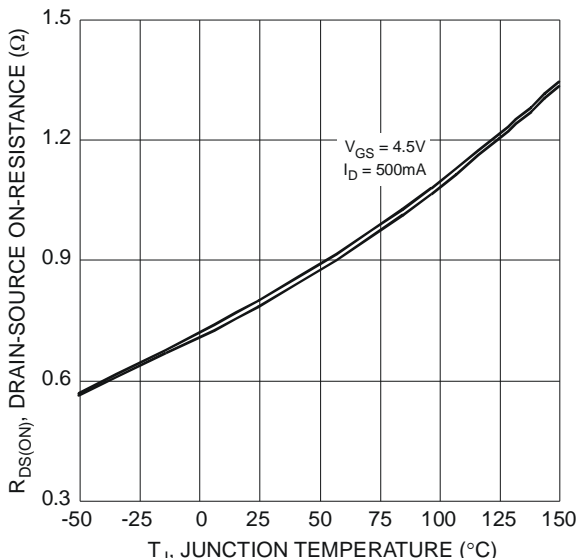


Figure 6 On-Resistance Variation with Temperature



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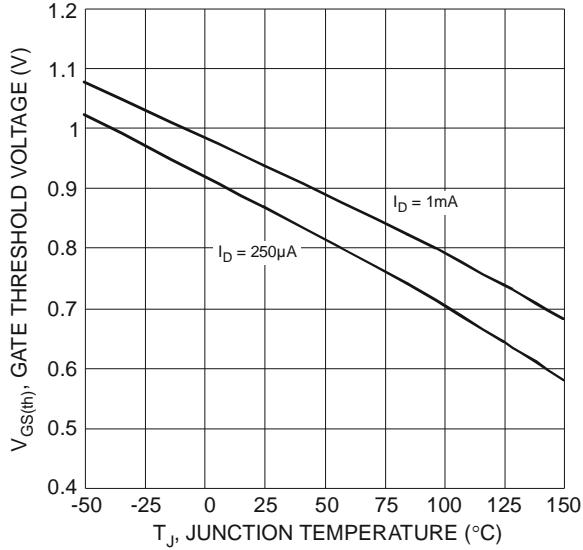


Figure 7 Gate Threshold Variation vs. Ambient Temperature

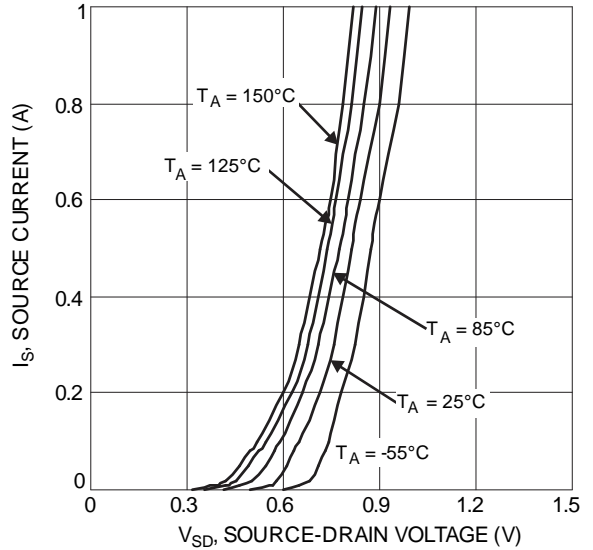


Figure 8 Diode Forward Voltage vs. Current

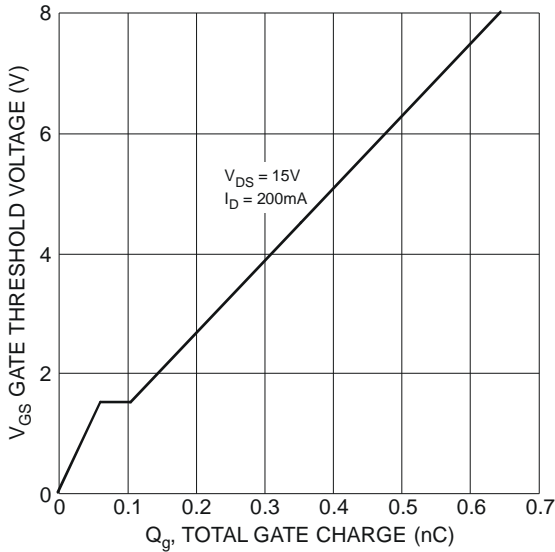


Figure 9 Gate Charge

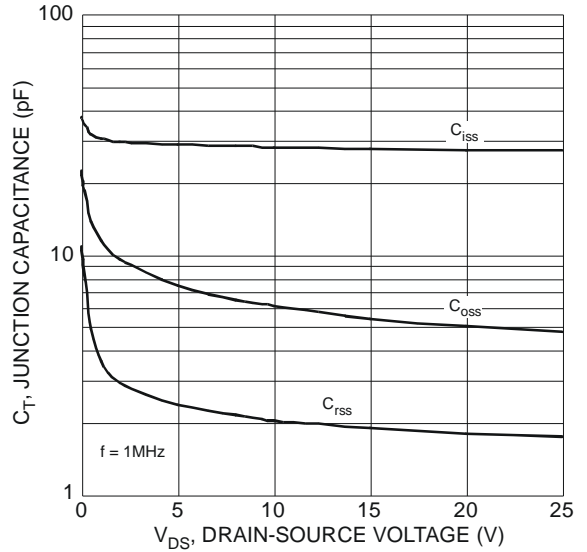


Figure 10 Typical Junction Capacitance

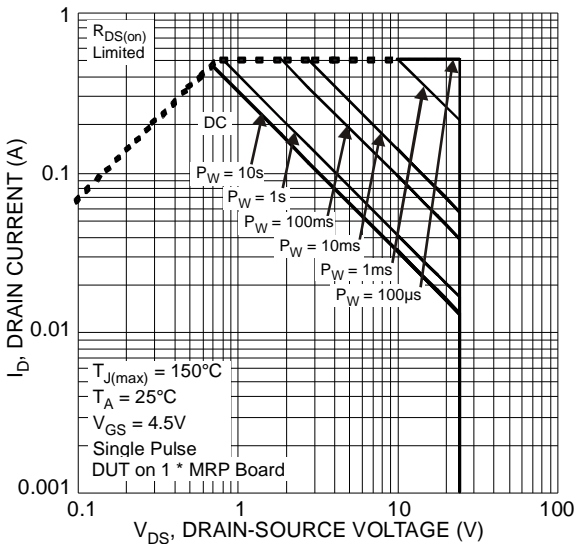
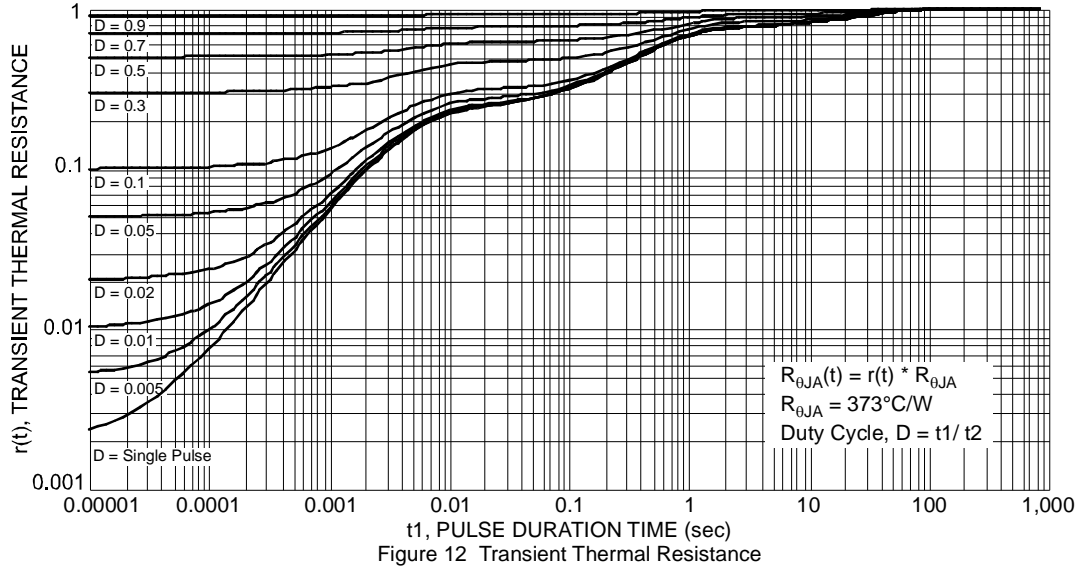


Figure 11 SOA, Safe Operation Area

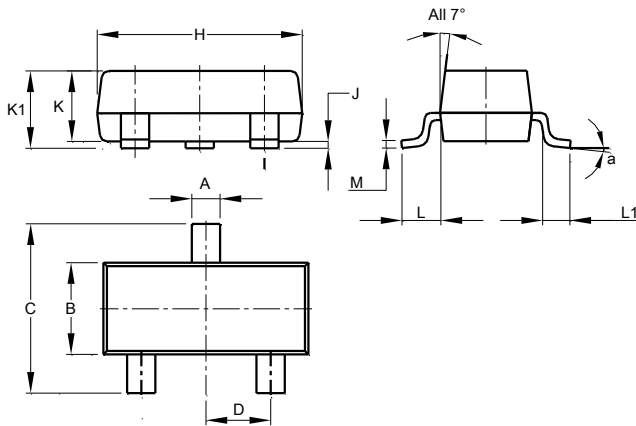


DMG301NU



Package Outline Dimensions

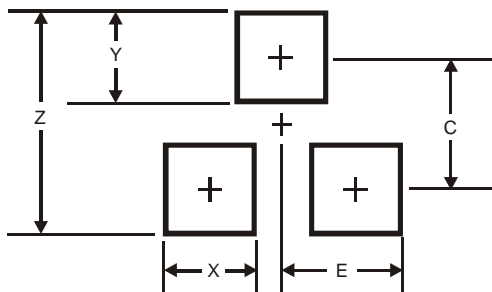
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	8°		
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35



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